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Standard Recommendation
S.R. CLC/TR 62453-515:2009

Field device tool (FDT) interface
specification -- Part 515:
Communication implementation for
common object model - IEC 61784 CPF
15 (IEC/TR 62453-515:2009 (EQV))

S.R. CLC/TR 62453-515:2009

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TECHNICAL REPORT
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CLC/TR 62453-515

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English version

**Field device tool (FDT) interface specification -
Part 515: Communication implementation for common object model -
IEC 61784 CPF 15
(IEC/TR 62453-515:2009)**

Spécification des interfaces des outils
des dispositifs de terrain (FDT) -
Partie 515: Implémentation
des communications
pour le modèle objet commun -
CEI 61784 CPF 15
(CEI/TR 62453-515:2009)

Field Device Tool (FDT) -
Schnittstellenspezifikation -
Teil 515: Kommunikationsimplementierung
mit dem allgemeinen Objektmodell (COM) -
Kommunikationsprofilfamilie (CPF) 15
nach IEC 61784
(IEC/TR 62453-515:2009)

This Technical Report was approved by CENELEC on 2009-10-01.

CENELEC members are the national electrotechnical committees of Austria, Belgium, Bulgaria, Cyprus, the Czech Republic, Denmark, Estonia, Finland, France, Germany, Greece, Hungary, Iceland, Ireland, Italy, Latvia, Lithuania, Luxembourg, Malta, the Netherlands, Norway, Poland, Portugal, Romania, Slovakia, Slovenia, Spain, Sweden, Switzerland and the United Kingdom.

CENELEC

European Committee for Electrotechnical Standardization
Comité Européen de Normalisation Electrotechnique
Europäisches Komitee für Elektrotechnische Normung

Central Secretariat: Avenue Marnix 17, B - 1000 Brussels

S.R. CLC/TR 62453-515:2009

CLC/TR 62453-515:2009

- 2 -

Foreword

The text of document 65E/71/CDV, future edition 1 of IEC/TR 62453-515, prepared by SC 65E, Devices and integration in enterprise systems, of IEC TC 65, Industrial-process measurement, control and automation, was submitted to the IEC-CENELEC parallel vote and was approved by CENELEC as CLC/TR 62453-515 on 2009-10-01.

This standard is to be used in conjunction with EN 62453-3xy series.

Annex ZA has been added by CENELEC.

Endorsement notice

The text of the Technical Report IEC/TR 62453-515:2009 was approved by CENELEC as a Technical Report without any modification.

In the official version, for Bibliography, the following note has to be added for the standard indicated:

IEC 61158-5-15 NOTE Harmonized as EN 61158-5-15:2008 (not modified).

Annex ZA (normative)

Normative references to international publications with their corresponding European publications

The following referenced documents are indispensable for the application of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE When an international publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 61131-3	- ¹⁾	Programmable controllers - Part 3: Programming languages	EN 61131-3	2003 ²⁾
IEC 61784-2	- ¹⁾	Industrial communication networks - Profiles - Part 2: Additional fieldbus profiles for real-time networks based on ISO/IEC 8802-3	EN 61784-2	2008 ²⁾
IEC 62453-1	2009	Field device tool (FDT) interface specification - Part 1: Overview and guidance	EN 62453-1	2009
IEC 62453-2	2009	Field device tool (FDT) interface specification - Part 2: Concepts and detailed description	EN 62453-2	2009
IEC/TR 62453-41	2009	Field device tool (FDT) interface specification - Part 41: Object model integration profile - Common object model	CLC/TR 62453-41	2009
IEC 62453-315	2009	Field device tool (FDT) interface specification - Part 315: Communication profile integration - IEC 61784 CPF 15	EN 62453-315	2009

¹⁾ Undated reference.

²⁾ Valid edition at date of issue.

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CONTENTS

FOREWORD..... 3

INTRODUCTION..... 5

1 Scope..... 6

2 Normative references 6

3 Terms, definitions, symbols, abbreviated terms and conventions 7

 3.1 Terms and definitions 7

 3.2 Symbols and abbreviated terms..... 7

 3.3 Conventions 7

 3.3.1 Data type names and references to data types 7

 3.3.2 Vocabulary for requirements 7

4 Bus category 7

5 Access to instance and device data 7

6 Protocol specific usage of general data types 7

7 Protocol specific common data types 8

8 Network management data types 8

 8.1 General 8

 8.2 Modbus device address - FDTModbusAddressSchema 8

9 Communication data types - FDTModbusCommunicationSchema 9

10 Channel parameter data types - FDTModbusChannelParameterSchema 17

11 Device identification 19

 11.1 Device type identification data types - FDTModbusIdentSchema 19

 11.2 Topology scan data types - DTModbusDeviceSchema 20

 11.3 Scan identification data types - FDTModbusScanIdentSchema 21

 11.4 Device type identification data types - FDTModbusDeviceTypeIdentSchema 23

 11.5 XSLT Transformation 24

Bibliography..... 30

Figure 1 – Part 515 of the IEC 62453 series 5

Table 1 – Protocol specific usage of general data types 8

INTERNATIONAL ELECTROTECHNICAL COMMISSION

FIELD DEVICE TOOL (FDT) INTERFACE SPECIFICATION –

**Part 515: Communication implementation for common object model –
IEC 61784 CPF 15**

FOREWORD

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The main task of IEC technical committees is to prepare International Standards. However, a technical committee may propose the publication of a technical report when it has collected data of a different kind from that which is normally published as an International Standard, for example "state of the art".

IEC/TR 62453-515, which is a technical report, has been prepared by subcommittee 65E: Devices and integration in enterprise systems, of IEC technical committee 65: Industrial-process measurement, control and automation:

This part, in conjunction with the other parts of the first edition of the IEC 62453 series cancels and replaces IEC/PAS 62453-1, IEC/PAS 62453-2, IEC/PAS 62453-3, IEC/PAS 62453-4 and IEC/PAS 62453-5 published in 2006, and constitutes a technical revision.

Each part of the IEC/TR 62453-5xy series is intended to be read in conjunction with its corresponding part in the IEC 62453-3xy series.

The text of this technical report is based on the following documents:

Enquiry draft	Report on voting
65E/71/DTR	65E/120/RVC

Full information on the voting for the approval of this technical report can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

The list of all parts of the IEC 62453 series, under the general title *Field Device Tool (FDT) interface specification*, can be found on the IEC website.

The committee has decided that the contents of this publication will remain unchanged until the maintenance result date indicated on the IEC web site under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

A bilingual version of this publication may be issued at a later date.

IMPORTANT – The “colour inside” logo on the cover page of this publication indicates that it contains colours which are considered to be useful for the correct understanding of its contents. Users should therefore print this publication using a colour printer.

INTRODUCTION

This part of IEC 62453 is an interface specification for developers of FDT (Field Device Tool) components for function control and data access within a client/server architecture. The specification is a result of an analysis and design process to develop standard interfaces to facilitate the development of servers and clients by multiple vendors that need to interoperate seamlessly.

With the integration of fieldbuses into control systems, there are a few other tasks which need to be performed. In addition to fieldbus- and device-specific tools, there is a need to integrate these tools into higher-level system-wide planning- or engineering tools. In particular, for use in extensive and heterogeneous control systems, typically in the area of the process industry, the unambiguous definition of engineering interfaces that are easy to use for all those involved is of great importance.

A device-specific software component, called DTM (Device Type Manager), is supplied by the field device manufacturer with its device. The DTM is integrated into engineering tools via the FDT interfaces defined in this specification. The approach to integration is in general open for all kind of fieldbuses and thus meets the requirements for integrating different kinds of devices into heterogeneous control systems.

Figure 1 shows how IEC/TR 62453-515 is aligned in the structure of IEC 62453 series.

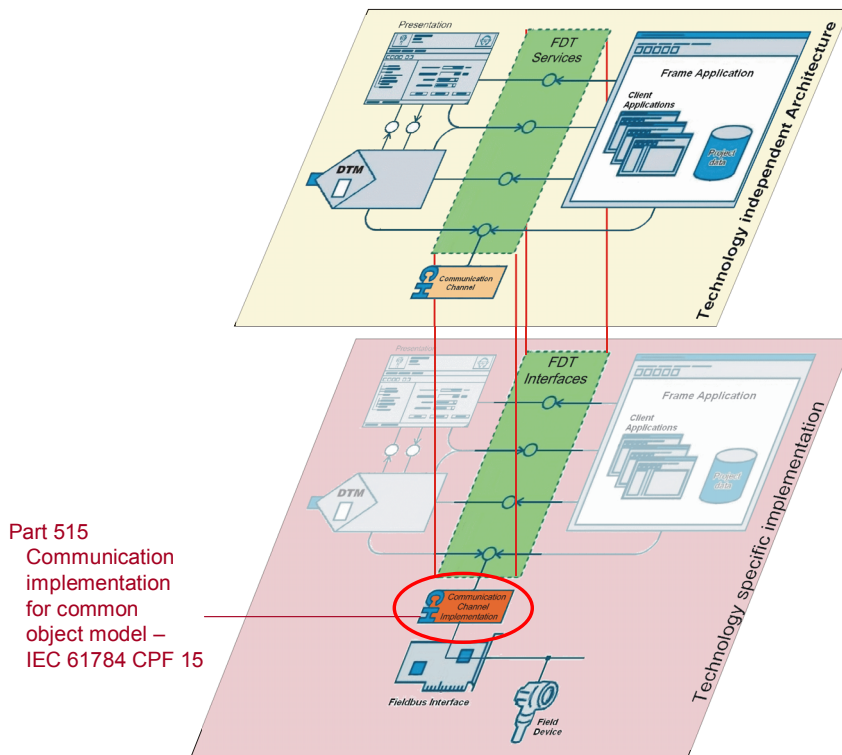


Figure 1 – Part 515 of the IEC 62453 series

FIELD DEVICE TOOL (FDT) INTERFACE SPECIFICATION –

Part 515: Communication implementation for common object model – IEC 61784 CPF 15

1 Scope

IEC/TR 62453-515, which is a technical report, provides information for integrating IEC 61784-2 CPF 15 (Modbus TCP®) and Modbus Serial Line®¹⁾ protocol support into FDT systems based on COM implementation. This part is to be used in conjunction with IEC/TR 62453-41.

NOTE This part of IEC 62453 only specifies the mapping of Modbus parameters to FDT data types. For restrictions of protocol specific parameters concerning allowed values and concerning limitations of arrays used in the definition of FDT data types, refer to IEC 61158-5-15 and the MODBUS Application Protocol Specification.

This part of IEC 62453 specifies communication and other services.

This specification neither contains the FDT specification nor modifies it.

2 Normative references

The following referenced documents are indispensable for the application of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 61131-3, *Programmable controllers – Part 3: Programming languages*

IEC 61784-2, *Industrial communication networks – Profiles – Part 2: Additional fieldbus profiles for real-time networks based on ISO/IEC 8802-3*

IEC 62453-1:2009, *Field Device Tool (FDT) interface specification – Part 1: Overview and guidance*

IEC 62453-2:2009, *Field Device Tool (FDT) interface specification – Part 2: Concepts and detailed description*

IEC/TR 62453-41:2009, *Field Device Tool (FDT) interface specification – Part 41: Object model integration profile – Common object model*

IEC 62453-315:2009, *Field Device Tool (FDT) interface specification – Part 315: Communication profile integration – IEC 61784 CPF 15*

1) Modbus is the trademark of Schneider Automation Inc. It is registered in the United States of America. This information is given for the convenience of users of this International Standard and does not constitute an endorsement by IEC of the trademark holder or any of its products. Compliance to this profile does not require use of the trademark Modbus. Use of the trademark Modbus requires permission from Schneider Automation Inc.

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